

## Features

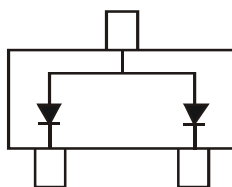
- Fast Switching Speed: 50ns
- High Reverse Breakdown Voltage Rating: 400V
- Low Leakage Current
- Surface Mount Package Ideally Suited for Automated Insertion
- **Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 2 & 3)**

## Mechanical Data

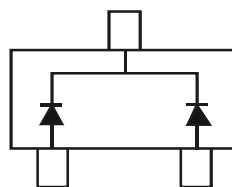
- Case: SOT23
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (approximate)



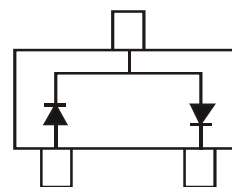
Top View



MMBD5004A



MMBD5004C



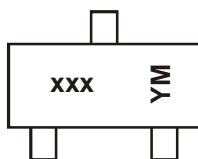
MMBD5004S

## Ordering Information (Note 4)

Part Number	Case	Packaging
MMBD5004S-7	SOT23	3000/Tape & Reel
MMBD5004C-7	SOT23	3000/Tape & Reel
MMBD5004A-7	SOT23	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
  3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com>.

## Marking Information



xxx = Product Type Marking Code  
 ex. KJB = MMBD5004S  
 CJK = MMBD5004C  
 AJK = MMBD5004A  
 YM = Date Code Marking  
 Y = Year (ex: Y = 2011)  
 M = Month (ex: 9 = September)

### Date Code Key

Year	2010	2011	2012	2013	2014	2015	2016	2017
Code	X	Y	Z	A	B	C	D	E

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	400	V
Working Peak Reverse Voltage	V <sub>RWM</sub>	350	V
DC Blocking Voltage	V <sub>R</sub>	247	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	247	V
Forward Continuous Current (Note 5)	I <sub>F</sub>	300	mA
Peak Repetitive Forward Current (Note 5)	I <sub>FRM</sub>	625	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0ms	I <sub>FSM</sub>	5 3	A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5) (See figure 1)	P <sub>D</sub>	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R <sub>θJA</sub>	357	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V <sub>(BR)R</sub>	400	—	—	V	I <sub>R</sub> = 150μA
Forward Voltage	V <sub>F</sub>	—	—	0.9 1.05 1.275	V	I <sub>F</sub> = 20mA I <sub>F</sub> = 100mA I <sub>F</sub> = 200mA
Reverse Current (Note 6)	I <sub>R</sub>	—	—	150 5	nA μA	V <sub>R</sub> = 240V V <sub>R</sub> = 360V
Total Capacitance	C <sub>T</sub>	—	0.65	2.0	pF	V <sub>R</sub> = 0V, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	—	—	50	ns	I <sub>F</sub> = I <sub>R</sub> = 30mA, I <sub>rr</sub> = 3.0mA, R <sub>L</sub> = 100Ω

Notes: 5. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.  
 6. Short duration pulse test used to minimize self-heating effect.

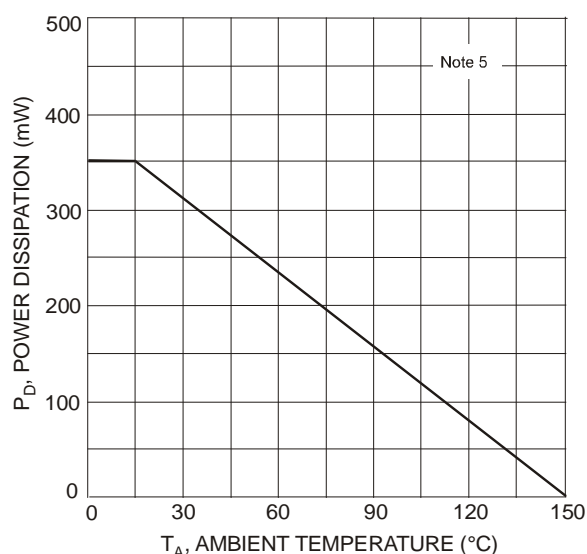


Fig. 1 Power Derating Curve, Total Package

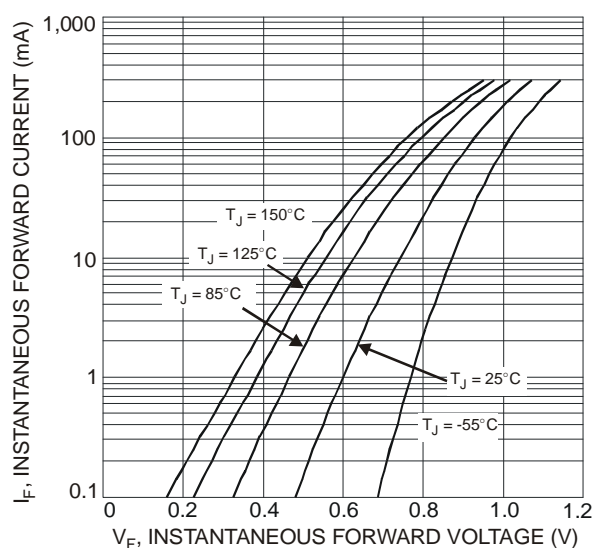


Fig. 2 Typical Forward Characteristics, Per Element

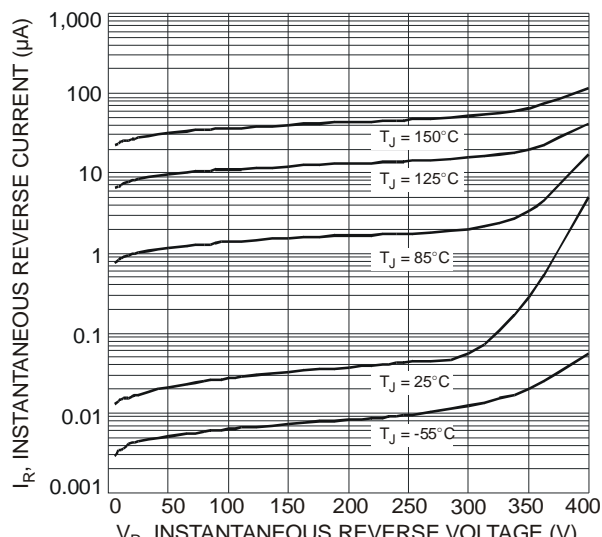


Fig. 3 Typical Reverse Characteristics, Per Element

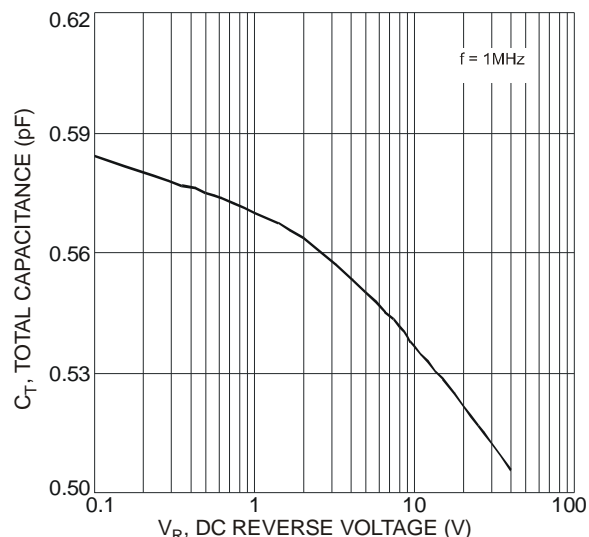
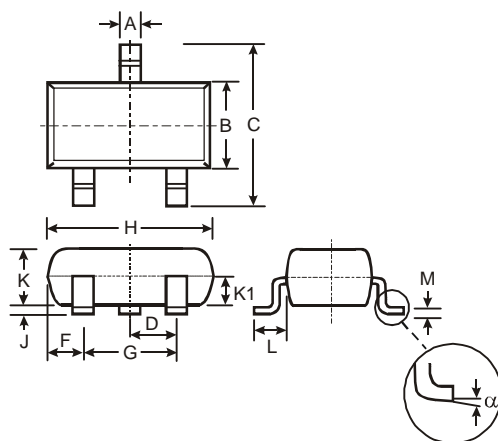


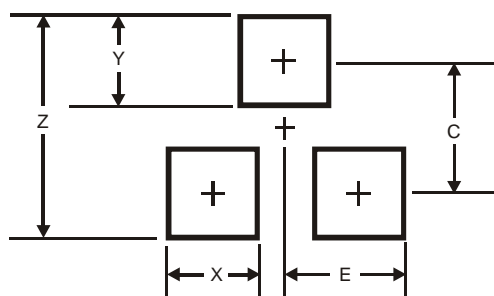
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

## Package Outline Dimensions



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
α	0°	8°	-
All Dimensions in mm			

## Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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